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JAN 09 2006

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Applicant: Theodore W. Houston

Docket Number: TI-32205.1

Serial No.: 10/664,547

Art Unit: 2822

Filed: 09/19/03

Examiner: Monica Lewis

For: Integrated DRAM Process/Structure Using Contact Pillars

CERTIFICATION OF FACSIMILE TRANSMISSION

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Karen Vertz
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FACSIMILE COVER SHEET

<input checked="" type="checkbox"/> FACSIMILE COVER SHEET	<input checked="" type="checkbox"/> AMENDMENT <u>111 (6 pages)</u>
<input type="checkbox"/> NEW APPLICATION	<input type="checkbox"/> EOT
<input type="checkbox"/> DECLARATION	<input type="checkbox"/> NOTICE OF APPEAL
<input type="checkbox"/> ASSIGNMENT	<input type="checkbox"/> APPEAL <u>(# Pages)</u>
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<input type="checkbox"/> CONTINUATION APP'N	<input type="checkbox"/> ELECTION
<input type="checkbox"/> DIVISIONAL APP'N	
NAME OF INVENTOR(S): Theodore W. Houston	
TITLE OF INVENTION: Integrated DRAM Process/Structure Using Contact Pillars	
TI FILE NO.: TI-32205.1	DEPOSIT ACCT. NO.: 20-0668
FAXED: 1-9-06 DUE: 1-20-06 ATTY/SECY: RAK/kjv	
RECEIPT DATE & SERIAL NO.: Serial No.: 10/664,547 Filing Date: 09/19/03	

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In re the Application of: Houston

Docket No.: TI-32205.1

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Examiner: Lewis, Monica

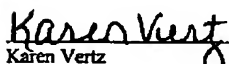
Title: Integrated DRAM Process/Structure Using Contact Pillars

AMENDMENT UNDER 37 CFR §1.111

January 9, 2006

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Commissioner:

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 Karen Vertz	<u>1-9-06</u> Date

In response to the Office Action, dated 10/20/2005, in the above-identified patent application, please make the following amendments. They are respectfully submitted as a full and complete response to that Action. Charge any required fees to the deposit account of Texas Instruments Incorporated, Account No. 20-0668.